

LMC660EP

CMOS Quad Operational Amplifier

General Description

The LMC660EP CMOS Quad operational amplifier is ideal for operation from a single supply. It operates from +5V to +15V and features rail-to-rail output swing in addition to an input common-mode range that includes ground. Performance limitations that have plagued CMOS amplifiers in the past are not a problem with this design. Input V_{OS} , drift, and broadband noise as well as voltage gain into realistic loads (2 k Ω and 600 Ω) are all equal to or better than widely accepted bipolar equivalents.

This chip is built with National's advanced Double-Poly Silicon-Gate CMOS process.

See the LMC662 datasheet for a dual CMOS operational amplifier with these same features.

ENHANCED PLASTIC

- Extended Temperature Performance of -40°C to $+85^{\circ}\text{C}$
- Baseline Control - Single Fab & Assembly Site
- Process Change Notification (PCN)
- Qualification & Reliability Data
- Solder (PbSn) Lead Finish is standard
- Enhanced Diminishing Manufacturing Sources (DMS) Support

Features

- Rail-to-rail output swing
- Specified for 2 k Ω and 600 Ω loads
- High voltage gain: 126 dB
- Low input offset voltage: 3 mV
- Low offset voltage drift: 1.3 $\mu\text{V}/^{\circ}\text{C}$
- Ultra low input bias current: 2 fA
- Input common-mode range includes V^{-}
- Operating range from +5V to +15V supply
- $I_{SS} = 375 \mu\text{A}/\text{amplifier}$; independent of V^{+}
- Low distortion: 0.01% at 10 kHz
- Slew rate: 1.1 V/ μs

Applications

- High-impedance buffer or preamplifier
- Precision current-to-voltage converter
- Long-term integrator
- Sample-and-Hold circuit
- Selected Military Applications
- Selected Avionics Applications

Ordering Information

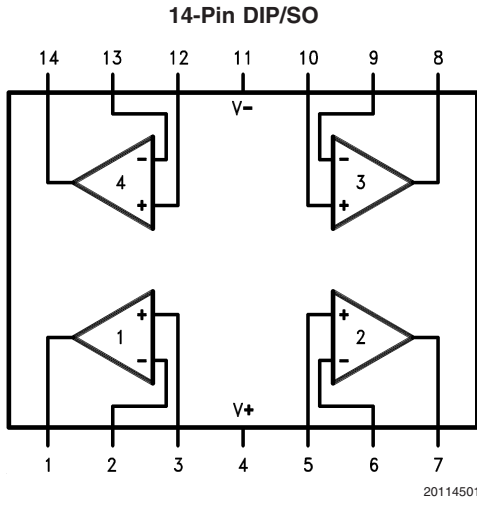
PART NUMBER	VID PART NUMBER	NS PACKAGE NUMBER (Note 3)
LMC660AIMEP	V62/04749-01	M14A
(Notes 1, 2)	TBD	TBD

Note 1: For the following (Enhanced Plastic) version, check for availability: LMC660AIMXEP, LMC660AINEP. Parts listed with an "X" are provided in Tape & Reel and parts without an "X" are in Rails.

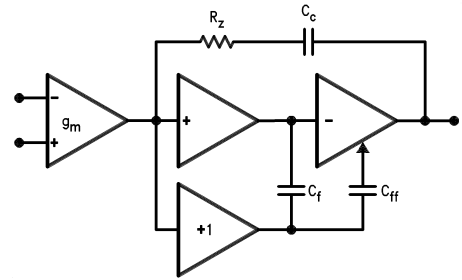
Note 2: FOR ADDITIONAL ORDERING AND PRODUCT INFORMATION, PLEASE VISIT THE ENHANCED PLASTIC WEB SITE AT: www.national.com/mil

Note 3: Refer to package details under Physical Dimensions

Connection Diagram



LMC660EP Circuit Topology (Each Amplifier)



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Absolute Maximum Ratings (Note 6)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Differential Input Voltage	±Supply Voltage
Supply Voltage	16V
Output Short Circuit to V ⁺	(Note 14)
Output Short Circuit to V ⁻	(Note 4)
Lead Temperature	
(Soldering, 10 sec.)	260°C
Storage Temp. Range	-65°C to +150°C
Voltage at Input/Output Pins	(V ⁺) + 0.3V, (V ⁻) - 0.3V
Current at Output Pin	±18 mA
Current at Input Pin	±5 mA

Current at Power Supply Pin	35 mA
Power Dissipation	(Note 5)
Junction Temperature	150°C
ESD tolerance (Note 11)	1000V

Operating Ratings

Temperature Range	
LMC660EP	-40°C ≤ T _J ≤ +85°C
Supply Voltage Range	4.75V to 15.5V
Power Dissipation	(Note 12)
Thermal Resistance (θ _{JA}) (Note 13)	
14-Pin Molded DIP	85°C/W
14-Pin SO	115°C/W

DC Electrical Characteristics Unless otherwise specified, all limits guaranteed for T_J = 25°C. **Boldface** limits apply at the temperature extremes. V⁺ = 5V, V⁻ = 0V, V_{CM} = 1.5V, V_O = 2.5V and R_L > 1M unless otherwise specified. (Note 15)

Parameter	Conditions	Typ (Note 7)	Limit (Note 7)	Units
Input Offset Voltage		1	3	mV
			3.3	max
Input Offset Voltage Average Drift		1.3		μV/°C
Input Bias Current		0.002	4	pA
			max	
Input Offset Current		0.001	2	pA
			max	
Input Resistance		>1		TeraΩ
Common Mode Rejection Ratio	0V ≤ V _{CM} ≤ 12.0V V ⁺ = 15V	83	70	dB
			68	min
Positive Power Supply Rejection Ratio	5V ≤ V ⁺ ≤ 15V V _O = 2.5V	83	70	dB
			68	min
Negative Power Supply Rejection Ratio	0V ≤ V ⁻ ≤ -10V	94	84	dB
			83	min
Input Common-Mode Voltage Range	V ⁺ = 5V & 15V For CMRR ≥ 50 dB	-0.4	-0.1	V
			0	max
			V ⁺ - 1.9	V ⁺ - 2.3 V⁺ - 2.5
Large Signal Voltage Gain	R _L = 2 kΩ (Note 8) Sourcing Sinking	2000	440	V/mV
			400	min
			500	180 120

DC Electrical Characteristics Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$. **Boldface** limits apply at the temperature extremes. $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{\text{CM}} = 1.5\text{V}$, $V_O = 2.5\text{V}$ and $R_L > 1\text{M}$ unless otherwise specified. (Note 15) (Continued)

Parameter	Conditions	Typ (Note 7)	Limit (Note 7)	Units	
	$R_L = 600\Omega$ (Note 8) Sourcing Sinking	1000	220	V/mV	
		250	200 100 60	min V/mV min	
Output Swing	$V^+ = 5\text{V}$ $R_L = 2\text{ k}\Omega$ to $V^+/2$	4.87	4.82	V	
		0.10	0.15 0.17	min V max	
	$V^+ = 5\text{V}$ $R_L = 600\Omega$ to $V^+/2$	4.61	4.41	V	
		0.30	0.50 0.56	min V max	
	$V^+ = 15\text{V}$ $R_L = 2\text{ k}\Omega$ to $V^+/2$	14.63	14.50	V	
		0.26	14.44 0.35 0.40	min V max	
	$V^+ = 15\text{V}$ $R_L = 600\Omega$ to $V^+/2$	13.90	13.35	V	
		0.79	13.15 1.16 1.32	min V max	
	Output Current $V^+ = 5\text{V}$	Sourcing, $V_O = 0\text{V}$	22	16	mA
		Sinking, $V_O = 5\text{V}$	21	14 16 14	min mA min
	Output Current $V^+ = 15\text{V}$	Sourcing, $V_O = 0\text{V}$	40	28	mA
		Sinking, $V_O = 13\text{V}$ (Note 14)	39	25 28	min mA
				24	min
Supply Current	All Four Amplifiers $V_O = 1.5\text{V}$	1.5	2.2	mA	
			2.6	max	

AC Electrical Characteristics Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$. **Boldface** limits apply at the temperature extremes. $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{\text{CM}} = 1.5\text{V}$, $V_{\text{O}} = 2.5\text{V}$ and $R_{\text{L}} > 1\text{M}$ unless otherwise specified. (Note 15)

Parameter	Conditions	Typ (Note 7)	Limit (Note 7)	Units
Slew Rate	(Note 9)	1.1	0.8 0.6	V/ μs min
Gain-Bandwidth Product		1.4		MHz
Phase Margin		50		Deg
Gain Margin		17		dB
Amp-to-Amp Isolation	(Note 10)	130		dB
Input Referred Voltage Noise	$F = 1\text{ kHz}$	22		nV/ $\sqrt{\text{Hz}}$
Input Referred Current Noise	$F = 1\text{ kHz}$	0.0002		pA/ $\sqrt{\text{Hz}}$
Total Harmonic Distortion	$F = 10\text{ kHz}$, $A_{\text{V}} = -10$ $R_{\text{L}} = 2\text{ k}\Omega$, $V_{\text{O}} = 8\text{ V}_{\text{PP}}$ $V^+ = 15\text{V}$	0.01		%

Note 4: Applies to both single supply and split supply operation. Continuous short circuit operation at elevated ambient temperature and/or multiple Op Amp shorts can result in exceeding the maximum allowed junction temperature of 150°C . Output currents in excess of $\pm 30\text{ mA}$ over long term may adversely affect reliability.

Note 5: The maximum power dissipation is a function of $T_{\text{J(max)}}$, θ_{JA} , and T_{A} . The maximum allowable power dissipation at any ambient temperature is $P_{\text{D}} = (T_{\text{J(max)}} - T_{\text{A}})/\theta_{\text{JA}}$.

Note 6: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 7: Typical values represent the most likely parametric norm. Limits are guaranteed by testing or correlation.

Note 8: $V^+ = 15\text{V}$, $V_{\text{CM}} = 7.5\text{V}$ and R_{L} connected to 7.5V . For Sourcing tests, $7.5\text{V} \leq V_{\text{O}} \leq 11.5\text{V}$. For Sinking tests, $2.5\text{V} \leq V_{\text{O}} \leq 7.5\text{V}$.

Note 9: $V^+ = 15\text{V}$. Connected as Voltage Follower with 10V step input. Number specified is the slower of the positive and negative slew rates.

Note 10: Input referred. $V^+ = 15\text{V}$ and $R_{\text{L}} = 10\text{ k}\Omega$ connected to $V^+/2$. Each amp excited in turn with 1 kHz to produce $V_{\text{O}} = 13\text{ V}_{\text{PP}}$.

Note 11: Human body model, $1.5\text{ k}\Omega$ in series with 100 pF .

Note 12: For operating at elevated temperatures the device must be derated based on the thermal resistance θ_{JA} with $P_{\text{D}} = (T_{\text{J}} - T_{\text{A}})/\theta_{\text{JA}}$.

Note 13: All numbers apply for packages soldered directly into a PC board.

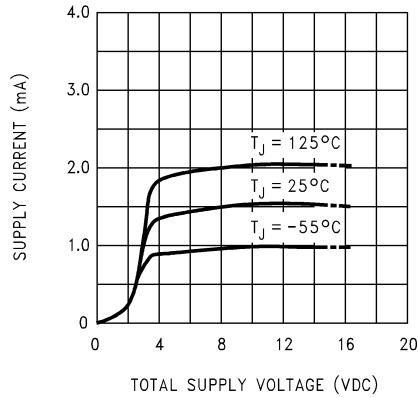
Note 14: Do not connect output to V^+ when V^+ is greater than 13V or reliability may be adversely affected.

Note 15: "Testing and other quality control techniques are used to the extent deemed necessary to ensure product performance over the specified temperature range. Product may not necessarily be tested across the full temperature range and all parameters may not necessarily be tested. In the absence of specific PARAMETRIC testing, product performance is assured by characterization and/or design."

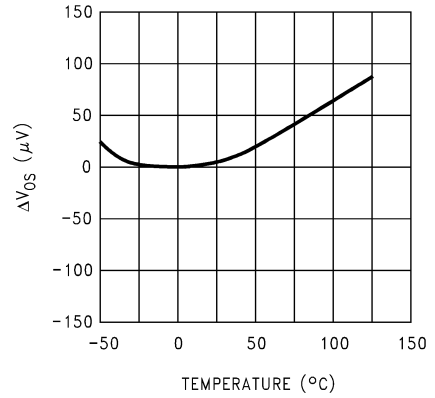
Typical Performance Characteristics

$V_S = \pm 7.5V$, $T_A = 25^\circ C$ unless otherwise specified

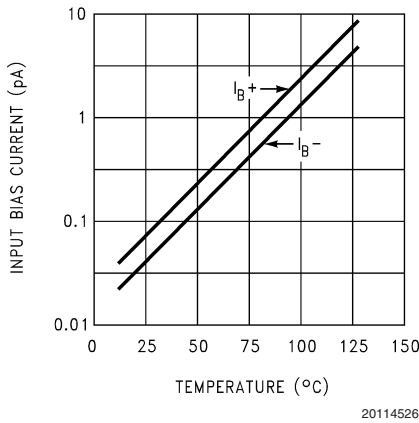
Supply Current vs Supply Voltage



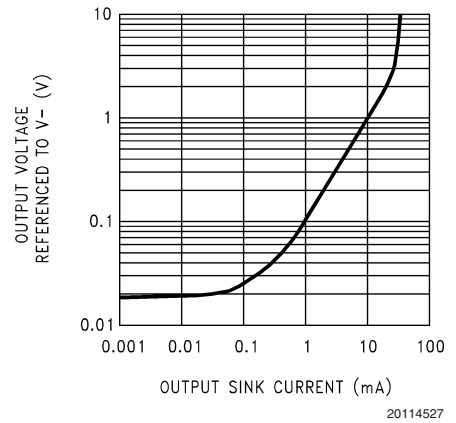
Offset Voltage



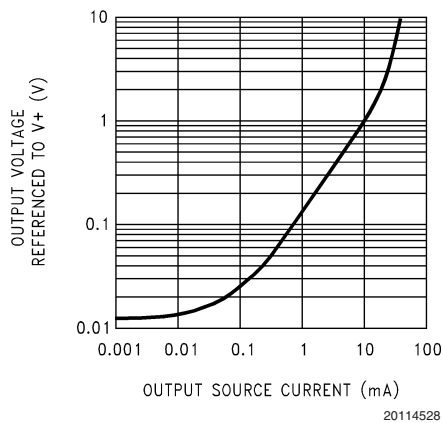
Input Bias Current



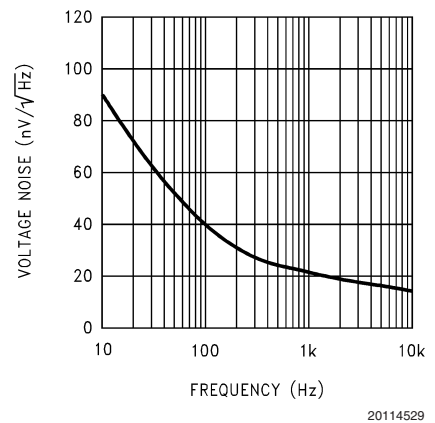
Output Characteristics Current Sinking



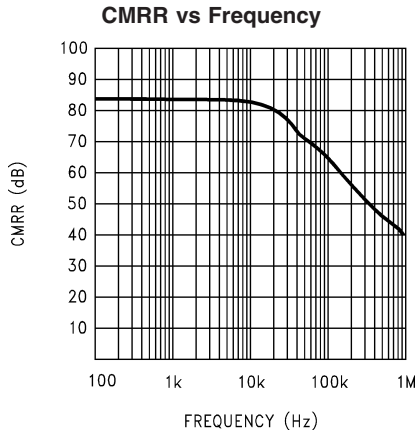
Output Characteristics Current Sourcing



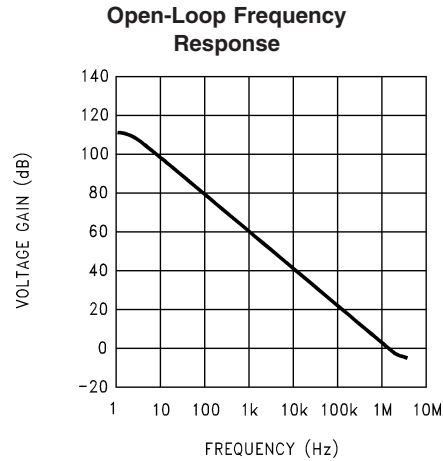
Input Voltage Noise vs Frequency



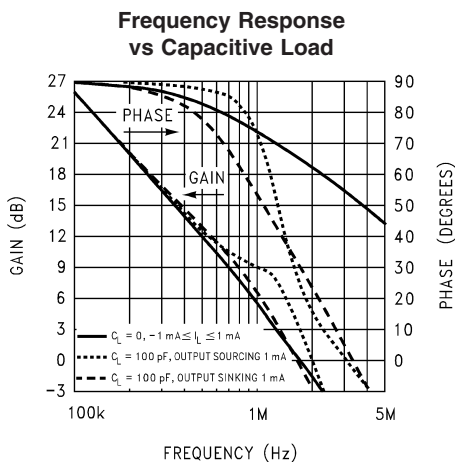
Typical Performance Characteristics $V_S = \pm 7.5V$, $T_A = 25^\circ C$ unless otherwise specified (Continued)



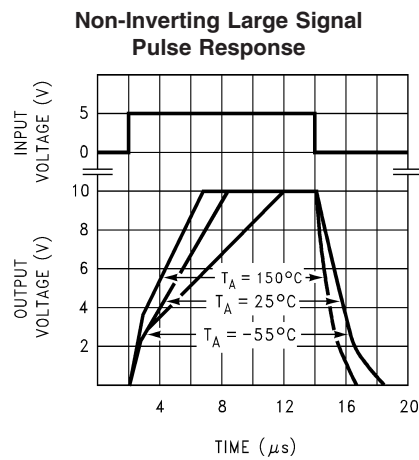
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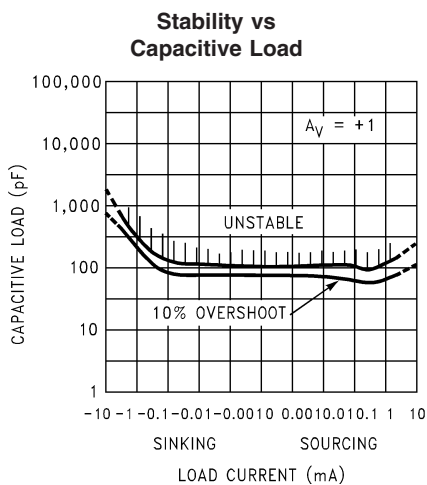
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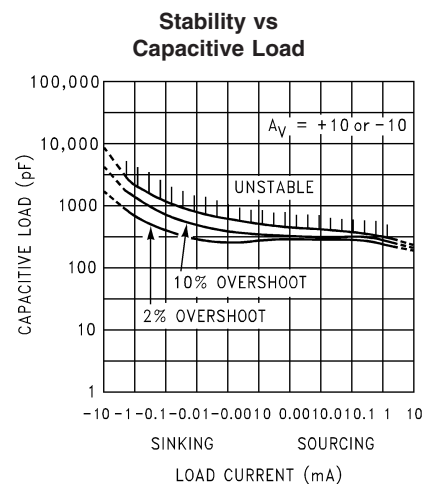
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Note: Avoid resistive loads of less than 500Ω, as they may cause instability.

Application Hints

AMPLIFIER TOPOLOGY

The topology chosen for the LMC660EP, shown in *Figure 1*, is unconventional (compared to general-purpose op amps) in that the traditional unity-gain buffer output stage is not

used; instead, the output is taken directly from the output of the integrator, to allow rail-to-rail output swing. Since the buffer traditionally delivers the power to the load, while maintaining high op amp gain and stability, and must withstand shorts to either rail, these tasks now fall to the integrator.

Application Hints (Continued)

As a result of these demands, the integrator is a compound affair with an embedded gain stage that is doubly fed forward (via C_f and C_{ff}) by a dedicated unity-gain compensation driver. In addition, the output portion of the integrator is a push-pull configuration for delivering heavy loads. While sinking current the whole amplifier path consists of three gain stages with one stage fed forward, whereas while sourcing the path contains four gain stages with two fed forward.

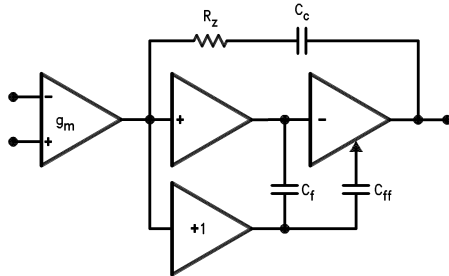


FIGURE 1. LMC660EP Circuit Topology (Each Amplifier)

The large signal voltage gain while sourcing is comparable to traditional bipolar op amps, even with a 600Ω load. The gain while sinking is higher than most CMOS op amps, due to the additional gain stage; however, under heavy load (600Ω) the gain will be reduced as indicated in the Electrical Characteristics.

COMPENSATING INPUT CAPACITANCE

The high input resistance of the LMC660EP op amps allows the use of large feedback and source resistor values without losing gain accuracy due to loading. However, the circuit will be especially sensitive to its layout when these large-value resistors are used.

Every amplifier has some capacitance between each input and AC ground, and also some differential capacitance between the inputs. When the feedback network around an amplifier is resistive, this input capacitance (along with any additional capacitance due to circuit board traces, the socket, etc.) and the feedback resistors create a pole in the feedback path. In the following General Operational Amplifier circuit, the frequency of this pole is *Figure 2*

$$f_p = \frac{1}{2\pi C_S R_P}$$

where C_S is the total capacitance at the inverting input, including amplifier input capacitance and any stray capacitance from the IC socket (if one is used), circuit board traces, etc., and R_P is the parallel combination of R_F and R_{IN} . This formula, as well as all formulae derived below, apply to inverting and non-inverting op-amp configurations.

When the feedback resistors are smaller than a few kΩ, the frequency of the feedback pole will be quite high, since C_S is generally less than 10 pF. If the frequency of the feedback pole is much higher than the “ideal” closed-loop bandwidth (the nominal closed-loop bandwidth in the absence of C_S), the pole will have a negligible effect on stability, as it will add only a small amount of phase shift.

However, if the feedback pole is less than approximately 6 to 10 times the “ideal” –3 dB frequency, a feedback capacitor, C_F , should be connected between the output and the inverting input of the op amp. This condition can also be stated in terms of the amplifier’s low-frequency noise gain: To maintain stability a feedback capacitor will probably be needed if

$$\left(\frac{R_F}{R_{IN}} + 1\right) \leq \sqrt{6 \times 2\pi \times GBW \times R_F \times C_S}$$

where

$$\left(\frac{R_F}{R_{IN}} + 1\right)$$

is the amplifier’s low-frequency noise gain and GBW is the amplifier’s gain bandwidth product. An amplifier’s low-frequency noise gain is represented by the formula

$$\left(\frac{R_F}{R_{IN}} + 1\right)$$

regardless of whether the amplifier is being used in inverting or non-inverting mode. Note that a feedback capacitor is more likely to be needed when the noise gain is low and/or the feedback resistor is large.

If the above condition is met (indicating a feedback capacitor will probably be needed), and the noise gain is large enough that:

$$\left(\frac{R_F}{R_{IN}} + 1\right) \geq 2\sqrt{GBW \times R_F \times C_S},$$

the following value of feedback capacitor is recommended:

$$C_F = \frac{C_S}{2\left(\frac{R_F}{R_{IN}} + 1\right)}$$

If

$$\left(\frac{R_F}{R_{IN}} + 1\right) < 2\sqrt{GBW \times R_F \times C_S}$$

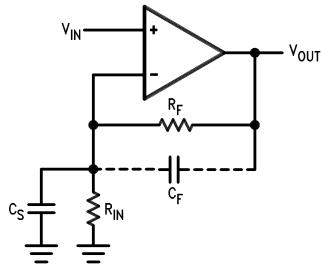
the feedback capacitor should be:

$$C_F = \sqrt{\frac{C_S}{GBW \times R_F}}$$

Note that these capacitor values are usually significant smaller than those given by the older, more conservative formula:

$$C_F = \frac{C_S R_{IN}}{R_F}$$

Application Hints (Continued)



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C_S consists of the amplifier's input capacitance plus any stray capacitance from the circuit board and socket. C_F compensates for the pole caused by C_S and the feedback resistors.

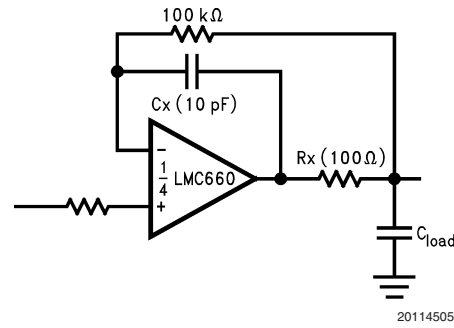
FIGURE 2. General Operational Amplifier Circuit

Using the smaller capacitors will give much higher bandwidth with little degradation of transient response. It may be necessary in any of the above cases to use a somewhat larger feedback capacitor to allow for unexpected stray capacitance, or to tolerate additional phase shifts in the loop, or excessive capacitive load, or to decrease the noise or bandwidth, or simply because the particular circuit implementation needs more feedback capacitance to be sufficiently stable. For example, a printed circuit board's stray capacitance may be larger or smaller than the breadboard's, so the actual optimum value for C_F may be different from the one estimated using the breadboard. In most cases, the values of C_F should be checked on the actual circuit, starting with the computed value.

CAPACITIVE LOAD TOLERANCE

Like many other op amps, the LMC660EP may oscillate when its applied load appears capacitive. The threshold of oscillation varies both with load and circuit gain. The configuration most sensitive to oscillation is a unity-gain follower. See Typical Performance Characteristics.

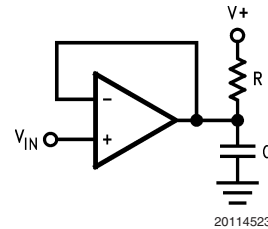
The load capacitance interacts with the op amp's output resistance to create an additional pole. If this pole frequency is sufficiently low, it will degrade the op amp's phase margin so that the amplifier is no longer stable at low gains. As shown in *Figure 3*, the addition of a small resistor (50Ω to 100Ω) in series with the op amp's output, and a capacitor (5 pF to 10 pF) from inverting input to output pins, returns the phase margin to a safe value without interfering with lower-frequency circuit operation. Thus larger values of capacitance can be tolerated without oscillation. Note that in all cases, the output will ring heavily when the load capacitance is near the threshold for oscillation.



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FIGURE 3. R_x , C_x Improve Capacitive Load Tolerance

Capacitive load driving capability is enhanced by using a pull up resistor to V^+ (*Figure 4*). Typically a pull up resistor conducting $500\ \mu\text{A}$ or more will significantly improve capacitive load responses. The value of the pull up resistor must be determined based on the current sinking capability of the amplifier with respect to the desired output swing. Open loop gain of the amplifier can also be affected by the pull up resistor (see Electrical Characteristics).



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FIGURE 4. Compensating for Large Capacitive Loads with a Pull Up Resistor

PRINTED-CIRCUIT-BOARD LAYOUT FOR HIGH-IMPEDANCE WORK

It is generally recognized that any circuit which must operate with less than 1000 pA of leakage current requires special layout of the PC board. When one wishes to take advantage of the ultra-low bias current of the LMC662, typically less than 0.04 pA , it is essential to have an excellent layout. Fortunately, the techniques for obtaining low leakages are quite simple. First, the user must not ignore the surface leakage of the PC board, even though it may sometimes appear acceptably low, because under conditions of high humidity or dust or contamination, the surface leakage will be appreciable.

To minimize the effect of any surface leakage, lay out a ring of foil completely surrounding the LMC660EP's inputs and the terminals of capacitors, diodes, conductors, resistors, relay terminals, etc. connected to the op-amp's inputs. See *Figure 5*. To have a significant effect, guard rings should be placed on both the top and bottom of the PC board. This PC foil must then be connected to a voltage which is at the same voltage as the amplifier inputs, since no leakage current can flow between two points at the same potential. For example, a PC board trace-to-pad resistance of $10^{12}\Omega$, which is normally considered a very large resistance, could leak 5 pA if the trace were a 5V bus adjacent to the pad of an input. This would cause a 100 times degradation from the LMC660EP's actual performance. However, if a guard ring is held within 5 mV of the inputs, then even a resistance of $10^{11}\Omega$ would

Application Hints (Continued)

cause only 0.05 pA of leakage current, or perhaps a minor (2:1) degradation of the amplifier's performance. See *Figure 6a*, *Figure 6b*, *Figure 6c* for typical connections of guard rings for standard op-amp configurations. If both inputs are active and at high impedance, the guard can be tied to ground and still provide some protection; see *Figure 6d*.

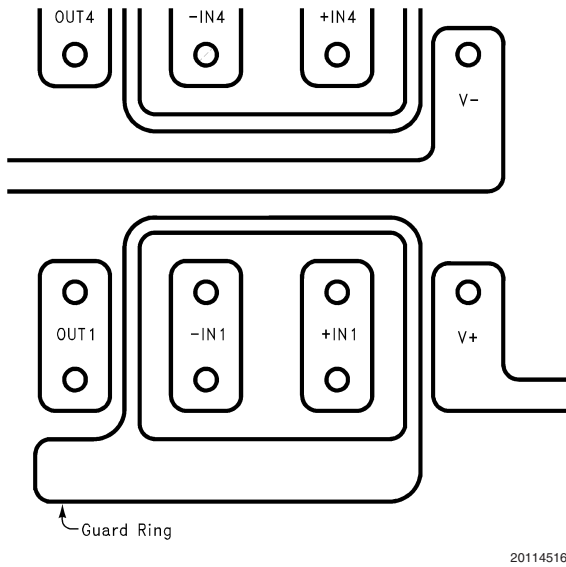
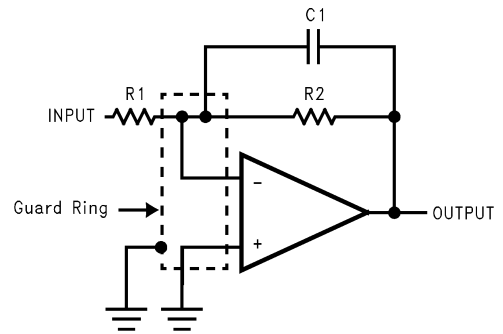
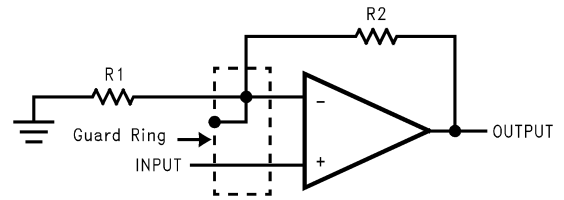


FIGURE 5. Example, using the LMC660AIMEP, of Guard Ring in P.C. Board Layout



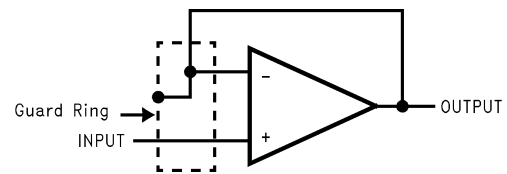
(a) Inverting Amplifier

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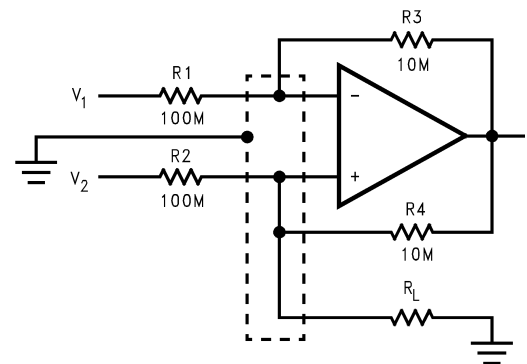
(b) Non-Inverting Amplifier

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(c) Follower

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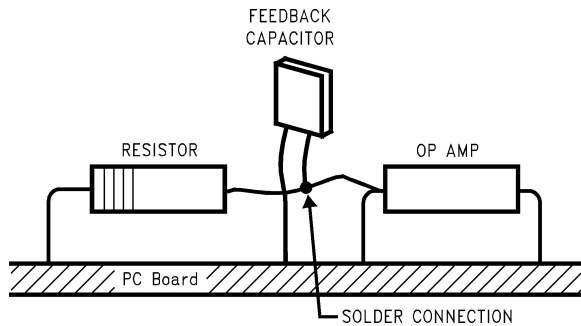
(d) Howland Current Pump

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FIGURE 6. Guard Ring Connections

The designer should be aware that when it is inappropriate to lay out a PC board for the sake of just a few circuits, there is another technique which is even better than a guard ring on a PC board: Don't insert the amplifier's input pin into the board at all, but bend it up in the air and use only air as an insulator. Air is an excellent insulator. In this case you may have to forego some of the advantages of PC board construction, but the advantages are sometimes well worth the effort of using point-to-point up-in-the-air wiring. See *Figure 7*.

Application Hints (Continued)



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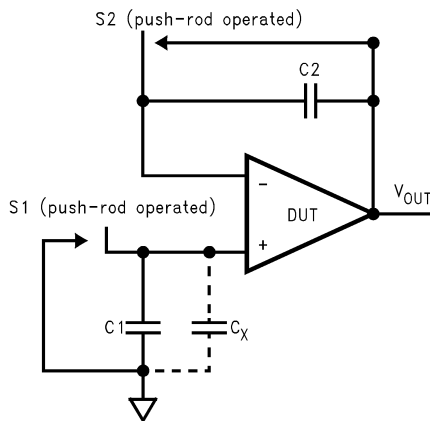
(Input pins are lifted out of PC board and soldered directly to components. All other pins connected to PC board.)

FIGURE 7. Air Wiring

Bias Current Testing

The test method of *Figure 8* is appropriate for bench-testing bias current with reasonable accuracy. To understand its operation, first close switch S2 momentarily. When S2 is opened, then

$$I_{b^{-}} = \frac{dV_{OUT}}{dt} \times C2.$$



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FIGURE 8. Simple Input Bias Current Test Circuit

A suitable capacitor for C2 would be a 5 pF or 10 pF silver mica, NPO ceramic, or air-dielectric. When determining the magnitude of $I_{b^{-}}$, the leakage of the capacitor and socket must be taken into account. Switch S2 should be left shorted most of the time, or else the dielectric absorption of the capacitor C2 could cause errors.

Similarly, if S1 is shorted momentarily (while leaving S2 shorted)

$$I_{b^{+}} = \frac{dV_{OUT}}{dt} \times (C1 + C_x)$$

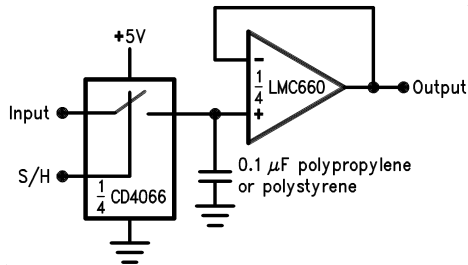
where C_x is the stray capacitance at the + input.

Typical Single-Supply Applications

(V+ = 5.0 VDC)

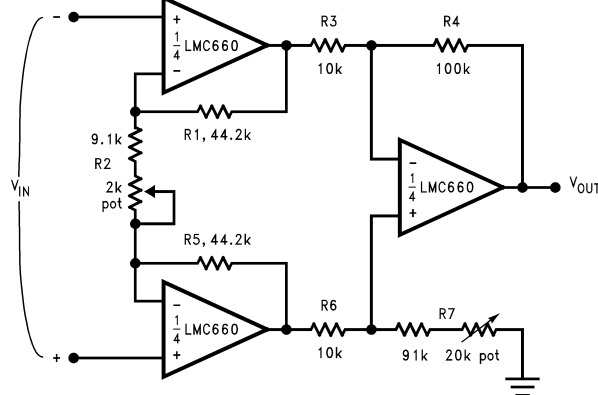
Additional single-supply applications ideas can be found in the LM324 datasheet. The LMC660EP is pin-for-pin compatible with the LM324 and offers greater bandwidth and input resistance over the LM324. These features will improve the performance of many existing single-supply applications. Note, however, that the supply voltage range of the LMC660EP is smaller than that of the LM324.

Low-Leakage Sample-and-Hold



20114507

Instrumentation Amplifier



20114508

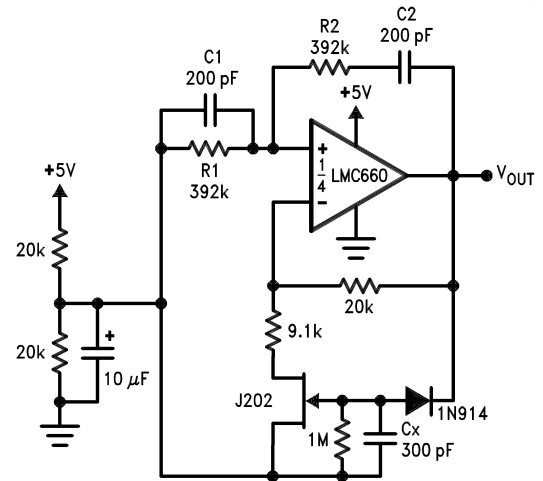
If R1 = R5, R3 = R6, and R4 = R7; then

$$\frac{V_{OUT}}{V_{IN}} = \frac{R2 + 2R1}{R2} \times \frac{R4}{R3}$$

∴ Av ≈ 100 for circuit shown.

For good CMRR over temperature, low drift resistors should be used. Matching of R3 to R6 and R4 to R7 affect CMRR. Gain may be adjusted through R2. CMRR may be adjusted through R7.

Sine-Wave Oscillator



20114509

Oscillator frequency is determined by R1, R2, C1, and C2:

$$f_{osc} = 1/2\pi RC, \text{ where } R = R1 = R2 \text{ and}$$

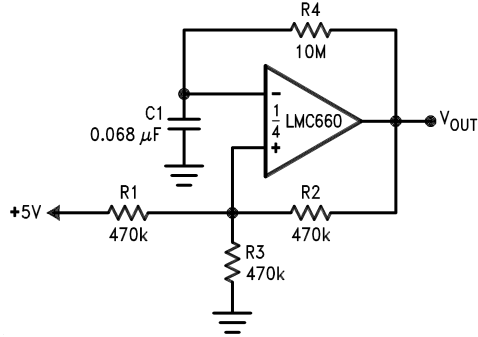
$$C = C1 = C2.$$

This circuit, as shown, oscillates at 2.0 kHz with a peak-to-peak output swing of 4.5V.

Typical Single-Supply Applications

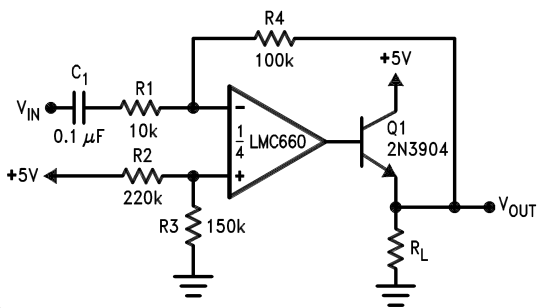
($V^+ = 5.0$ VDC) (Continued)

1 Hz Square-Wave Oscillator



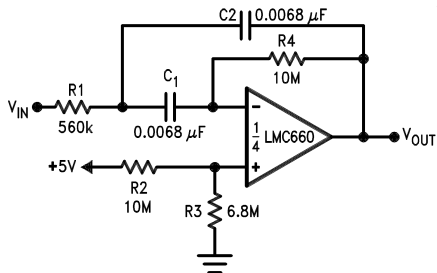
20114510

Power Amplifier



20114511

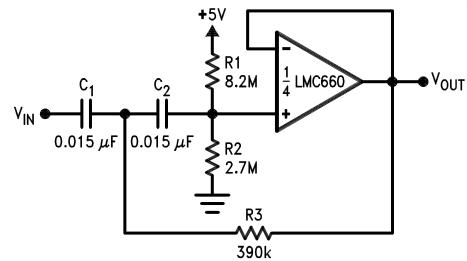
10 Hz Bandpass Filter



20114512

$f_0 = 10$ Hz
 $Q = 2.1$
 Gain = -8.8

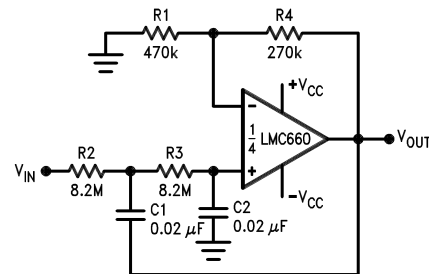
10 Hz High-Pass Filter



20114513

$f_c = 10$ Hz
 $d = 0.895$
 Gain = 1
 2 dB passband ripple

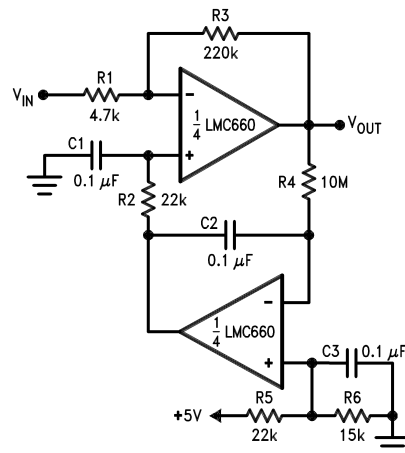
1 Hz Low-Pass Filter (Maximally Flat, Dual Supply Only)



20114514

$f_c = 1$ Hz
 $d = 1.414$
 Gain = 1.57

High Gain Amplifier with Offset Voltage Reduction

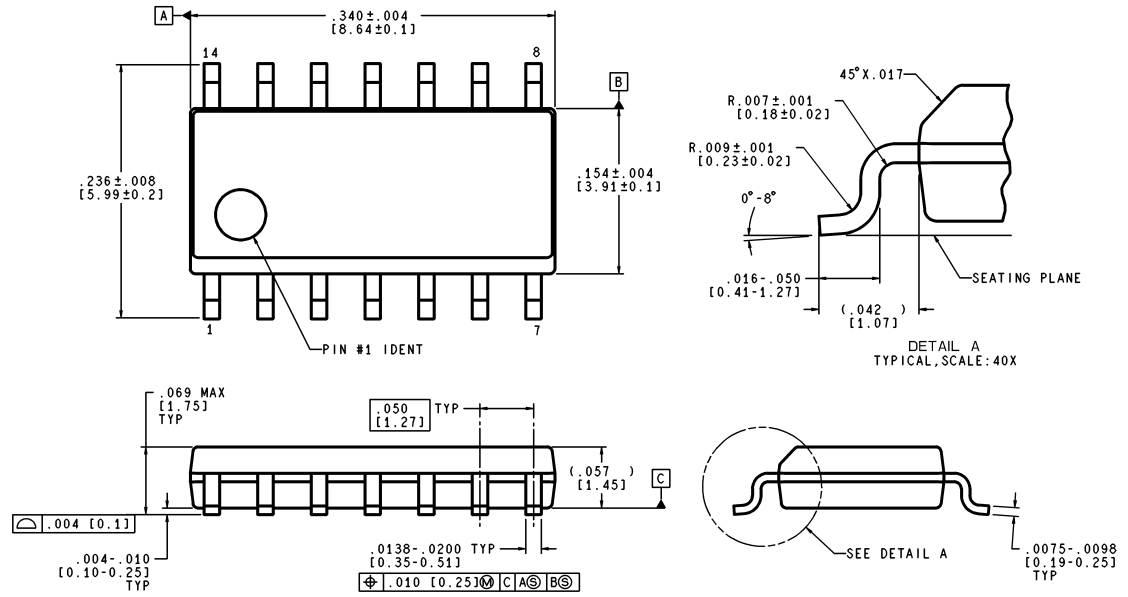


20114515

Gain = -46.8
 Output offset voltage reduced to the level of the input offset voltage of the bottom amplifier (typically 1 mV).

Physical Dimensions inches (millimeters)

unless otherwise noted

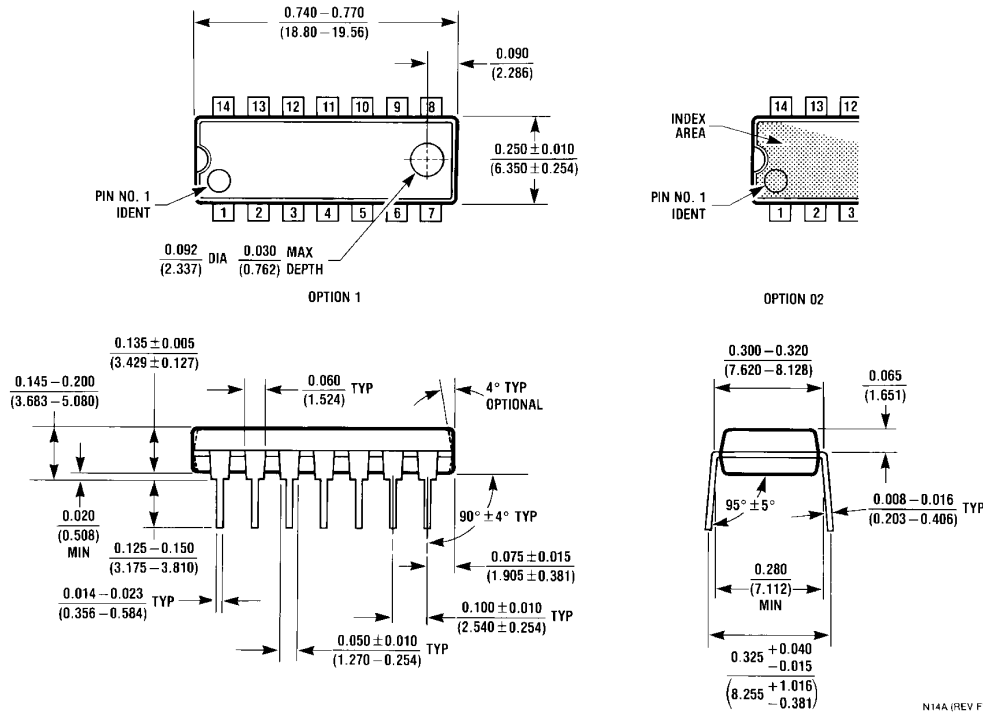


CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

M14A (Rev. J)

Small Outline Dual-In-Line Pkg. (M)
NS Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**Molded Dual-In-Line Pkg. (N)
NS Package Number N14A**

N14A (REV F)

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